



## DECLARATION FOR PATENT APPLICATION

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name. I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled **REF1 Modified Plants and Plant Seeds**, the specification of which was filed on **November 07, 2005** as Application Serial No. \*\*\*. I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information, which is material to the patentability as defined in Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119, of any foreign application(s) for patent or inventor's certificate listed below, and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

PCT/US04/14489

PCT

5/7/2004

Yes

*Number*

*Country*

*Day/Month/Year Filed*

*Priority Claimed*

I hereby claim the benefit under Title 35, United States Code, § 120, of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a), that occurred between the filing date of the prior application and the national or PCT international filing date of this application:

60/468,608

07 May 2003

Pending

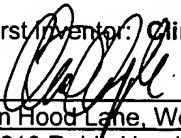
*Application Serial No.*

*Filing Date*

*Patented, Pending, or Abandoned*

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under § 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of Sole or First Inventor: **Clint Chapple**


Inventor's Signature: 


Date: 8.22.06

Residence: 2210 Robin Hood Lane, West Lafayette, Indiana 47906

Citizenship: United States of America

Post Office Address: 2210 Robin Hood Lane, West Lafayette, Indiana 47906

Residence: 15 Hitching Post Road; West Lafayette IN 47906 

Post Office Address: 15 Hitching Post Road; West Lafayette, IN 47906 

Full Name of Second Joint Inventor: **Ramesh Nair**

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_

Residence: 2505 NW Parkridge Drive, Ankeny, IA 50021

Citizenship: United States of America

Post Office Address: 2505 NW Parkridge Drive, Ankeny, IA 50021



**PATENT**  
Attorney Docket No.: **PRF-10329**

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80/488,608

07 May 2003

Pending

*Application Serial No.**Filing Date**Patented, Pending, or Abandoned*

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under § 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of Sole or First Inventor: **Clint Chapple**

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_

Residence: 2210 Robin Hood Lane, West Lafayette, Indiana 47906Citizenship: United States of AmericaPost Office Address: 2210 Robin Hood Lane, West Lafayette, Indiana 47906

Full Name of Second Joint Inventor: **Ramesh Nair**

Inventor's Signature: \_\_\_\_\_

Date: August, 25, 2006Residence: 2505 NW Parkridge Drive, Ankeny, IA 50021Citizenship: United States of AmericaPost Office Address: 2505 NW Parkridge Drive, Ankeny, IA 50021